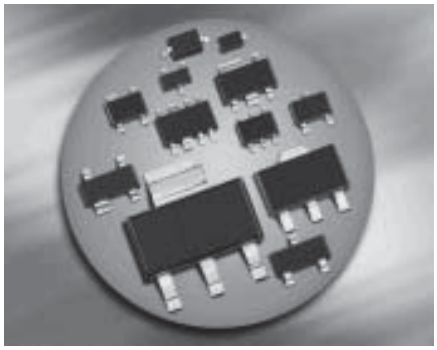
THE DATASHEET OF

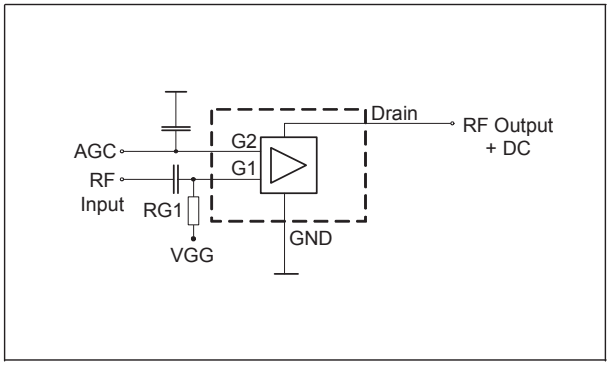
BF2030WE6814BTSA1

Silicon N-Channel MOSFET Tetrode



- For low noise, high gain controlled input stages up to 1GHz
- Operating voltage 5V
- Pb-free (RoHS compliant) package [1)]
- Qualified according AEC Q101

AEC Qualified RoHS



ESD (**E**lectro**s**tatic **d**ischarge) sensitive device, observe handling precaution!

Class 2 (2000V - 4000V) pin to pin **H**uman **B**ody **M**odel

Type	Package	Pin Configuration						Marking
BF2030	SOT143	1= S	2=D	3=G2	4=G1	-	-	NDs
BF2030R	SOT143R	1= D	2=S	3=G1	4=G2	-	-	NDs
BF2030W	SOT343	1= D	2=S	3=G1	4=G2	-	-	NDs

Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	8	V
Continuous drain current	I_D	40	mA
Gate 1/ gate 2-source current	$\pm I_{G1/2SM}$	10	
Gate 1 (external biasing)	$+V_{G1SE}$	6	V
Total power dissipation	P_{tot}		mW
$T_S \leq 76$ °C, BF2030, BF2030R		200	
$T_S \leq 94$ °C, BF2030W		200	
Storage temperature	T_{stg}	-55 ... 150	°C
Channel temperature	T_{ch}	150	

[1]Pb-containing package may be available upon special request

Thermal Resistance

Parameter	Symbol	Value	Unit
Channel - soldering point[1)]	R_{thchs}		K/W
BF2030/ BF2030R		≤370	
BF2030W		≤280	

Electrical Characteristics at T_A = 25°C, unless otherwise specified

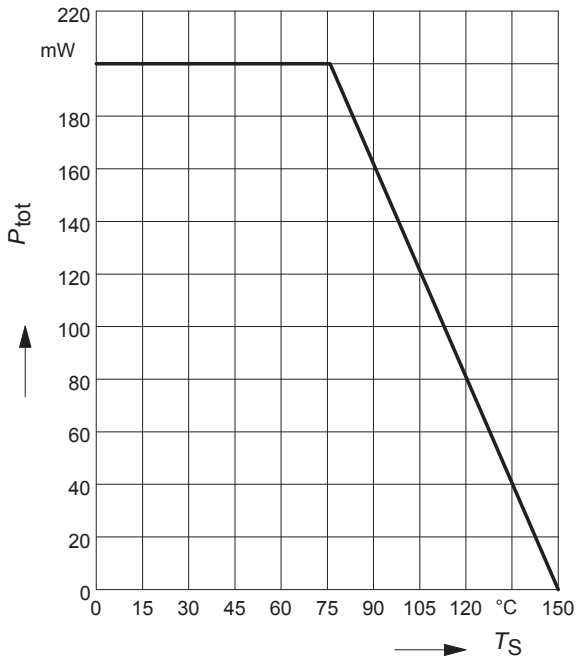
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Drain-source breakdown voltage I_D = 20 µA, V_{G1S} = 0 , V_{G2S} = 0	$V_{(BR)DS}$	10	-	-	V
Gate1-source breakdown voltage +I_{G1S} = 10 mA, V_{G2S} = 0 , V_{DS} = 0	+$V_{(BR)G1SS}$	6	-	15	
Gate2-source breakdown voltage +I_{G2S} = 10 mA, V_{G1S} = 0 , V_{DS} = 0	+$V_{(BR)G2SS}$	6	-	15	
Gate1-source leakage current V_{G1S} = 5 V, V_{G2S} = 0 , V_{DS} = 0	+I_{G1SS}	-	-	50	nA
Gate2-source leakage current V_{G2S} = 5 V, V_{G1S} = 0 , V_{DS} = 0	+I_{G2SS}	-	-	50	
Drain current V_{DS} = 5 V, V_{G1S} = 0 , V_{G2S} = 4 V	I_{DSS}	-	-	50	µA
Drain-source current V_{DS} = 5 V, V_{G2S} = 4 V, R_{G1} = 100 kΩ	I_{DSX}	-	12	-	mA
Gate1-source pinch-off voltage V_{DS} = 5 V, V_{G2S} = 4 V, I_D = 20 µA	$V_{G1S(p)}$	0.3	0.5	-	V
Gate2-source pinch-off voltage V_{DS} = 5 V, I_D = 20 µA	$V_{G2S(p)}$	0.3	0.6	-	

[1]For calculation of R_{thJA} please refer to Application Note Thermal Resistance

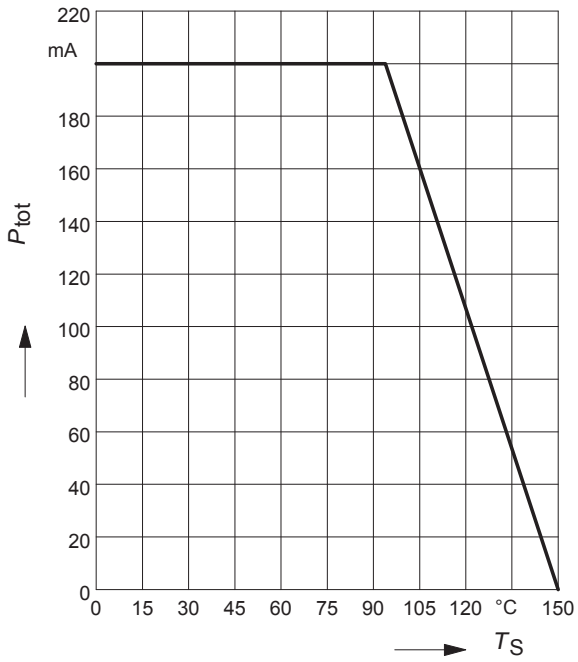
Electrical Characteristics at T_A = 25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling)					
Forward transconductance V_{DS} = 5 V, I_D = 10 mA, V_{G2S} = 4 V	g_{fs}	27	31	-	mS
Gate1 input capacitance V_{DS} = 5 V, I_D = 10 mA, V_{G2S} = 4 V, f = 10 MHz	C_{g1ss}	-	2.4	2.8	pF
Output capacitance V_{DS} = 5 V, I_D = 10 mA, V_{G2S} = 4 V, f = 10 MHz	C_{dss}	-	1.3	-	
Power gain V_{DS} = 5 V, I_D = 10 mA, V_{G2S} = 4 V, f = 800 MHz	G_p	20	23	-	dB
Noise figure V_{DS} = 5 V, I_D = 10 mA, V_{G2S} = 4 V, f = 800 MHz	F	-	1.5	2.2	dB
Gain control range V_{DS} = 5 V, V_{G2S} = 4...0 V, f = 800 MHz	ΔG_p	40	50	-	

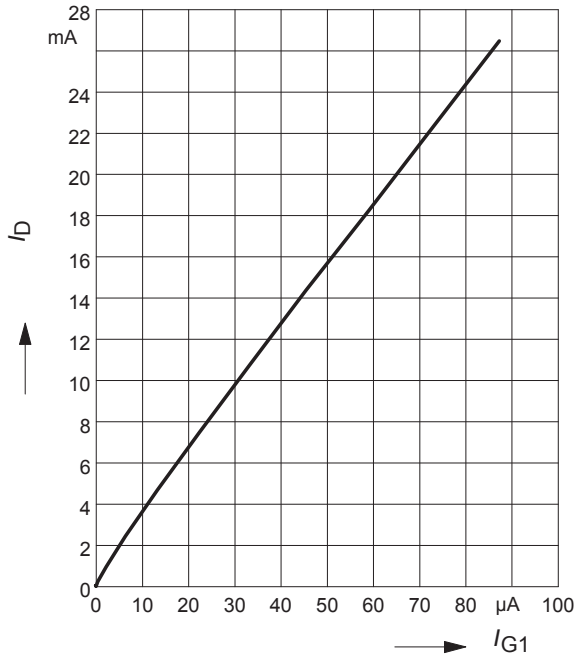
Total power dissipation $P_{tot} = f(T_S)$
BF2030, BF2030R



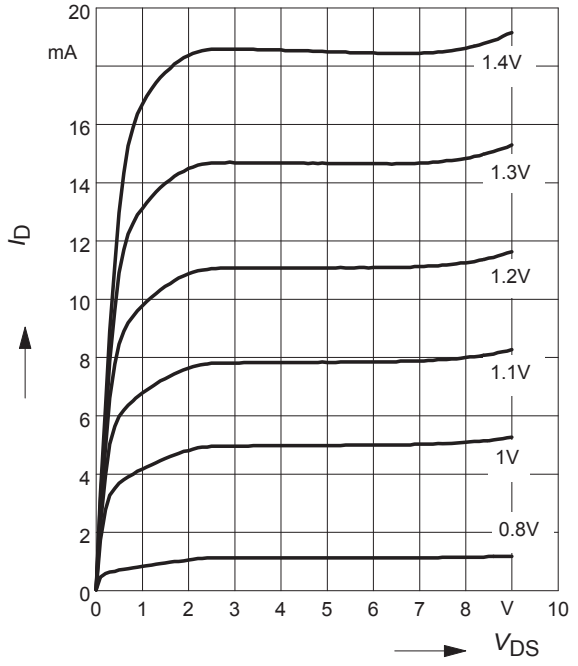
Total power dissipation $P_{tot} = f(T_S)$
BF2030W



Drain current $I_D = f(I_{G1})$
V_{G2S} = 4V



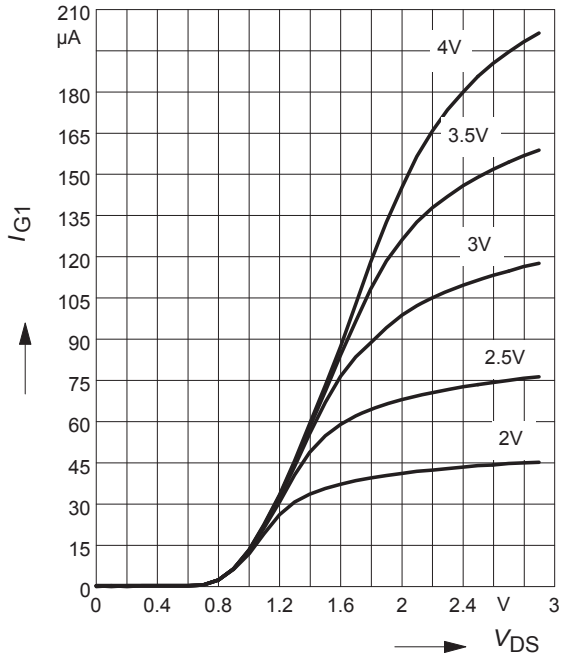
Output characteristics $I_D = f(V_{DS})$
V_{G2S} = 4V
V_{G1S} = Parameter



Gate 1 current $I_{G1} = f(V_{G1S})$

V_{DS} = 5V

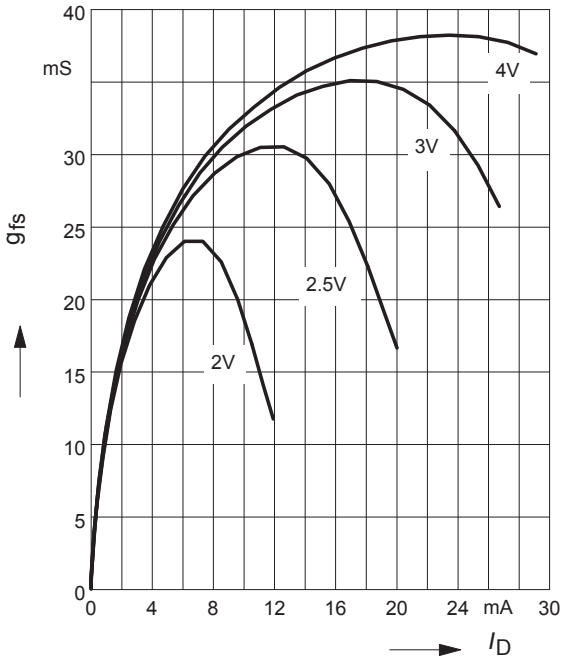
V_{G2S} = Parameter



Gate 1 forward transconductance

$g_{fs} = f(I_D)$

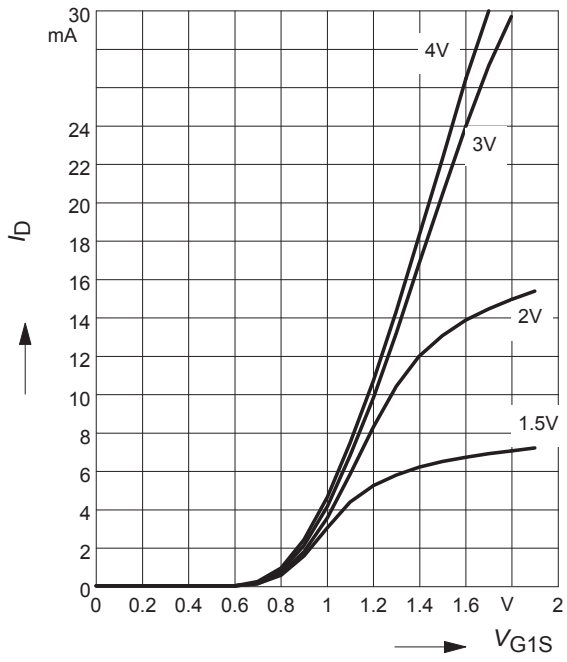
V_{DS} = 5V, V_{G2S} = Parameter



Drain current $I_D = f(V_{G1S})$

V_{DS} = 5V

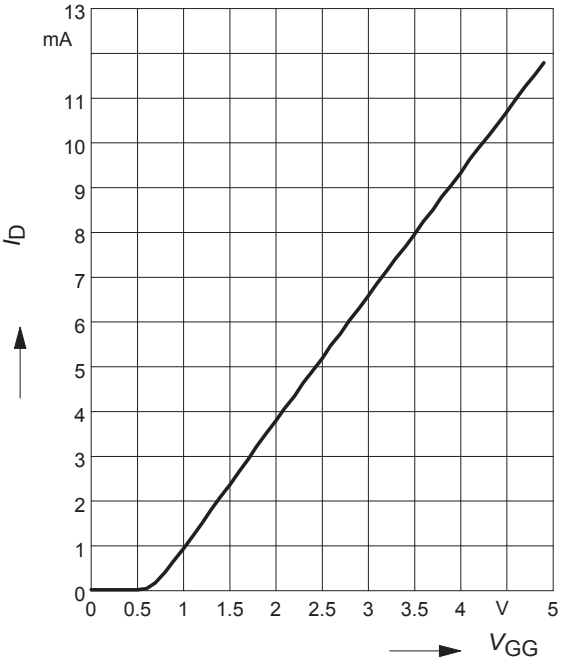
V_{G2S} = Parameter



Drain current $I_D = f(V_{GG})$

V_{DS} = 5V, V_{G2S} = 4V, R_{G1} = 100kΩ

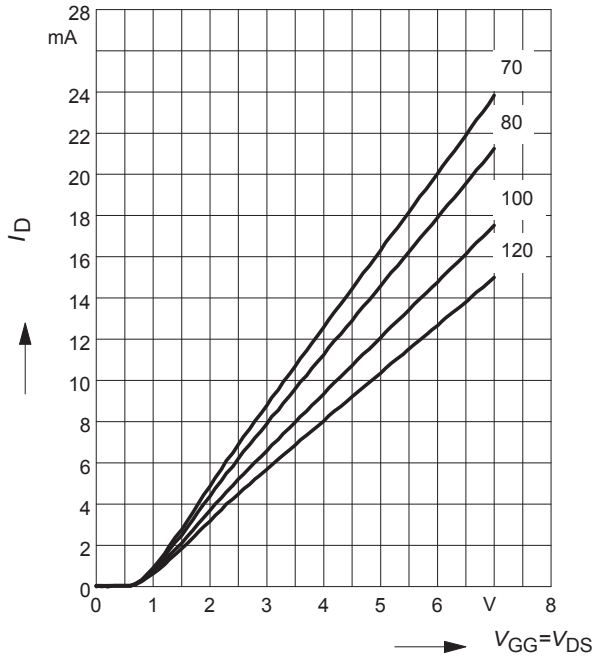
(connected to V_{GG}, V_{GG}=gate1 supply voltage)



Drain current $I_D = f(V_{GG})$

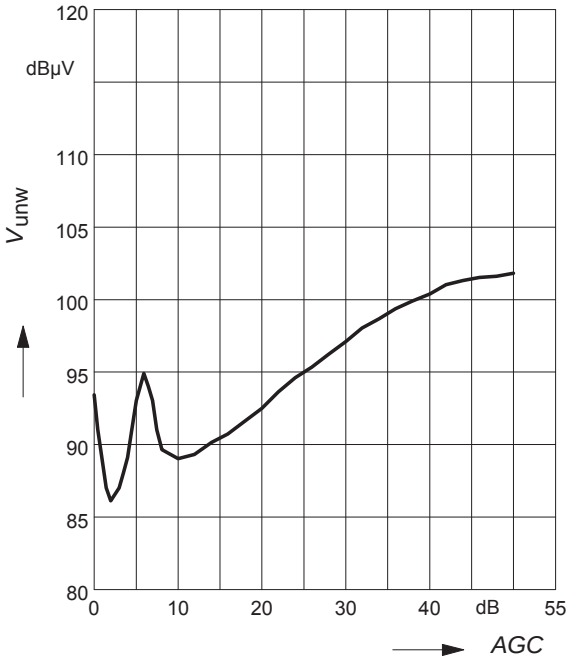
V_{G2S} = 4V

R_{G1} = Parameter in kΩ

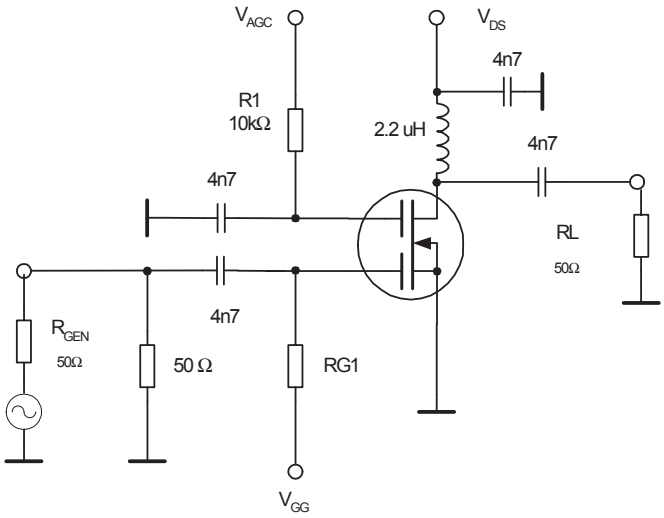


Crossmodulation V_{unw} = (*AGC*)

V_{DS} = 5 V

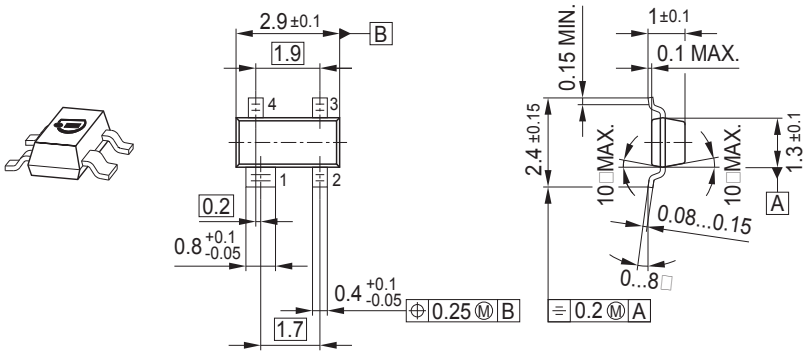


Cossmodulation test circuit

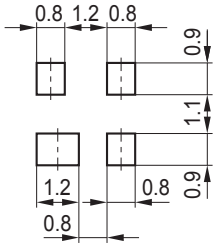


Semibiased

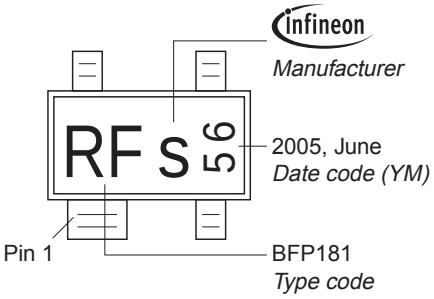
Package Outline



Foot Print

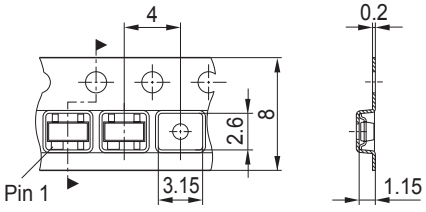


Marking Layout (Example)

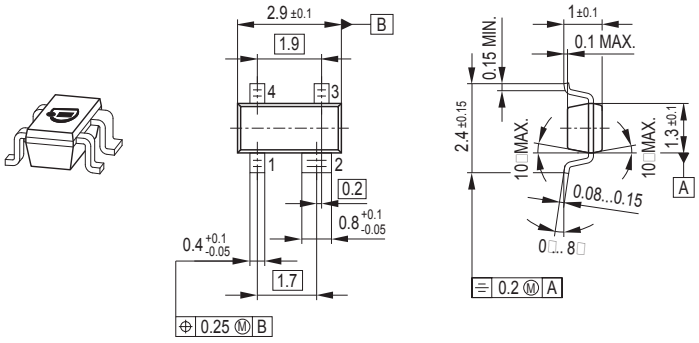


Standard Packing

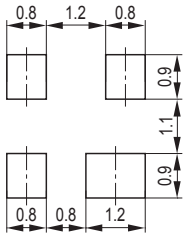
Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel



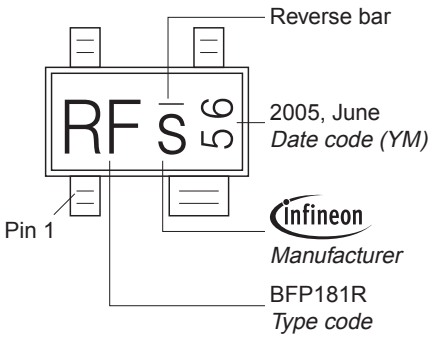
Package Outline



Foot Print

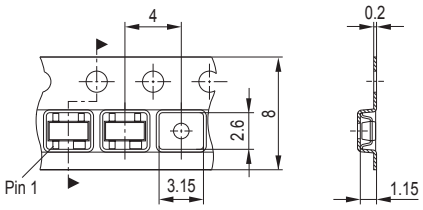


Marking Layout (Example)

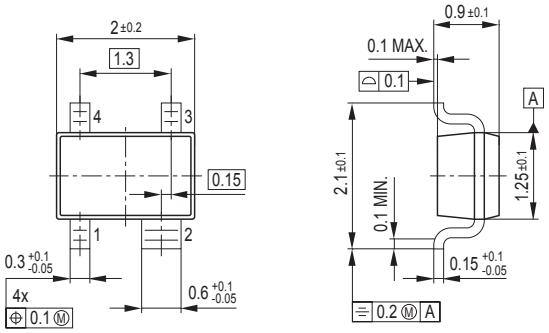


Standard Packing

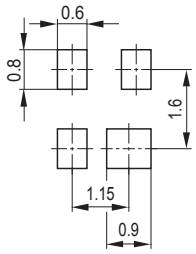
Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel



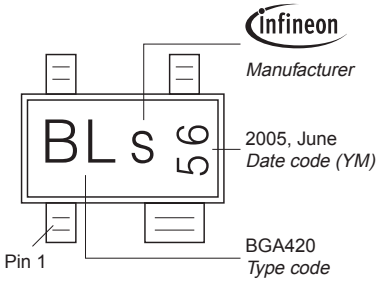
Package Outline



Foot Print

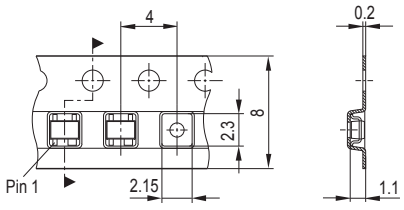


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel



Edition 2006-02-01
Published by
Infineon Technologies AG
81726 München, Germany

Attention please!

The information given in this dokument shall in no event be regarded as a guarantee of conditions or characteristics (“Beschaffenheitsgarantie”). With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (**www.infineon.com**).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.
Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system.
Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

- View BF2030WE6814BTSA1 on WIN SOURCE
- Infineon Technologies Information

Optimize Your Supply Chain with WIN SOURCE Solutions

- Global Sourcing Solution
- Obsolete Management
- Cost Control Management
- Shortage Management
- Alternative Solution
- Excess Inventory Management